

#### **DATA SHEET**

# SKY67183-396LF: 400 to 6000 MHz Broadband Low-Noise Amplifier

### **Applications**

- FDD and TDD 4G LTE and 5G NR systems
- Active antenna array and massive MIMO
- Receive LNA for micro-cell, macro-cell, and small cell base stations
- Land mobile radios and military communications
- · Low-noise broadband gain block and driver amplifier

#### **Features**

- · Low-noise amplifier:
  - Very low noise figure
  - Temperature and process-stable active bias up to +115 °C
  - Wide operating voltage range
  - Low gain slope over operating band
  - Excellent input return loss
- · Integrated controller:
  - Stable amplifier bias
  - Temperature compensation
  - True logic level thresholds
  - Fast response time
- Excellent broadband flat gain performance
- . Minimal BOM count
- Low current Inp 56 mA @ 5 V
- Fast rise/fall time ENABLE function suitable for TDD application
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)





Skyworks Green<sup>™</sup> products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*<sup>™</sup>, document number SQ04–0074.

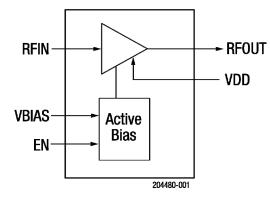


Figure 1. SKY67183-396LF Block Diagram

## **Description**

The SKY67183-396LF is a wide-band low-noise amplifier with superior gain flatness and exceptional linearity.

The compact 2 x 2 mm, 8-pin Dual Flat No Lead packaged LNA is designed for FDD and TDD 4G LTE and 5G NR infrastructure systems operating from 400 to 6000 MHz.

The internal active bias circuitry provides stable performance over temperature and process variation.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

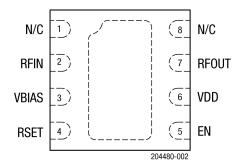


Figure 2. SKY67183-396LF Pinout (Top View)

Table 1. SKY67183-396LF Signal Descriptions

| Pin | Name  | Description  |  | Name  | Description  |
|-----|-------|--|--|-------|--|
| 1   | N/C   | N/C No connection (may be connected to ground with no change in performance) |  | EN    | Enable voltage to LNA  |
| 2   | RFIN  | RF input (DC blocking capacitor required)                                    |  | VDD   | VDD voltage to LNA   |
| 3   | VBIAS | Bias voltage for input gate  |  | RFOUT | RF output. DC blocking capacitor is required.                            |
| 4   | RSET  | RSET External resistor to set bias current                                   |  | N/C   | No connection (may be connected to ground with no change in performance) |

# **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY67183-396LF are provided in Table 2. Recommended operating conditions are shown in Table 3. Thermal data is shown in Table 4. Electrical specifications are provided in Tables 5, 6, 7, and 8.

Table 2. SKY67183-396LF Absolute Maximum Ratings<sup>1</sup>

| Parameter  | Symbol | Minimum | Maximum     | Units  |
|--|--------|---------|-------------|--------|
| Supply voltage   | VDD    |         | 5.5         | V      |
| LNA enable   | EN     | -0.5    | 2.8         | ٧      |
| Quiescent supply current   | IDQ    |         | 100         | mA     |
| RF input power (C/W)   | Pin    |         | +22         | dBm    |
| Storage temperature  | Tstg   | -40     | +150        | °C     |
| Operating temperature  | TA     | -40     | +115        | °C     |
| Junction temperature   | TJ     |         | +150        | °C     |
| Electrostatic discharge:   | ESD    |         |             |        |
| Charged Device Model (CDM), Class C3<br>Human Body Model (HBM), Class 1A |        |         | 1000<br>250 | V<br>V |

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

**Table 3. SKY67183-396LF Recommended Operating Conditions** 

| Parameter         | Symbol | Min  | Тур | Max  | Units |
|-------------------|--------|------|-----|------|-------|
| Supply voltage    | VDD    | 3.3  | 5.0 | 5.25 | V     |
| LNA enable:<br>ON | EN     |      | 0   | 0.63 | ٧     |
| OFF OFF           |        | 1.17 | 1.8 | 2.4  | V     |

Table 4. SKY67183-396LF Electrical Specifications: Thermal Data<sup>1</sup> (VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = No RF, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

| Parameter   | Symbol | Test Condition   | Min | Тур  | Max | Units |
|---|--------|--|-----|------|-----|-------|
| Thermal resistance  | ӨЈС    |  |     | 79.8 |     | °C/W  |
| Channel temperature @ +115 °C reference (package heat slug) | TJ     | $V_{DD} = 5.0 \text{ V}, I_{DQ} = 61 \text{ mA}, \text{ no RF}$ applied, dissipated power = 0.31 W |     | 139  |     | °C    |

<sup>&</sup>lt;sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

Table 5. SKY67183-396LF Electrical Specifications: 4200 to 4900 MHz Optimized BoM in Table  $8^1$  (VDD = 5.0 V, Enable = GND, Ta = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , f = 4500 MHz, Unless Otherwise Noted)

| Parameter   | Symbol     | Test Condition                         | Min  | Тур                  | Max               | Units             |
|---|------------|--|------|----------------------|-------------------|-------------------|
| RF Specifications   | <u>'</u>   |  |      |                      | •                 |                   |
| Noise figure  | NF         | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz |      | 0.5<br>0.5<br>0.6    | 1.0<br>1.0<br>1.1 | dB<br>dB<br>dB    |
| Small signal gain   | IS21I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 16.5 | 18.2<br>18.2<br>17.7 |                   | dB<br>dB<br>dB    |
| Input return loss   | IS11I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 12   | 16.1<br>32.8<br>21.9 |                   | dB<br>dB<br>dB    |
| Output return loss  | IS22I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 10   | 11.2<br>23.2<br>14.9 |                   | dB<br>dB<br>dB    |
| Reverse isolation   | IS12I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 26   | 32<br>32<br>32       |                   | dB<br>dB<br>dB    |
| Third order output intercept<br>(-20 dBm input/1 MHz tone)          | OIP3       | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | +27  | +29<br>+29<br>+28.5  |                   | dBm<br>dBm<br>dBm |
| 1 dB output compression point                                       | OP1dB      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | +16  | +20<br>+19<br>+20    |                   | dBm<br>dBm<br>dBm |
| DC Specifications   |            |  |      |                      |                   |                   |
| Supply voltage  | VDD        |  |      | 5.0                  |                   | ٧                 |
| Quiescent current   | IDD        |  | 45   | 56                   | 67                | mA                |
| Settling time 0.3 dB <sup>2</sup> Settling time 0.1 dB <sup>3</sup> | TS1<br>TS2 | @ 4500 MHz                             |      | 0.3<br>0.31          | 0.9<br>0.9        | us<br>us          |

Performance is guaranteed only under the conditions listed in this table.

<sup>&</sup>lt;sup>2</sup> Settling time 0.3 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady-state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady-state "on" level.

# Typical Performance Characteristics 4200 to 4900 MHz (VDD = 5 V, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , Unless Otherwise Noted)

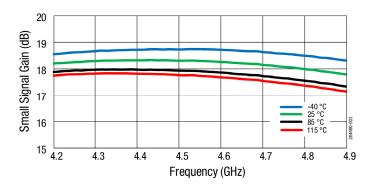
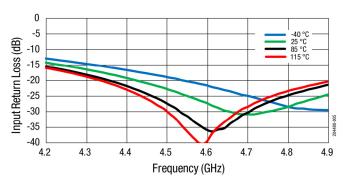


Figure 3. Small Signal Gain (dB) vs Frequency (GHz)

Figure 4. Noise Figure (dB) vs Frequency (GHz)



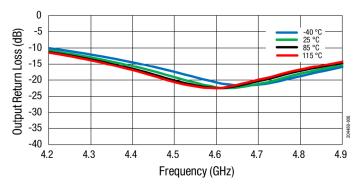
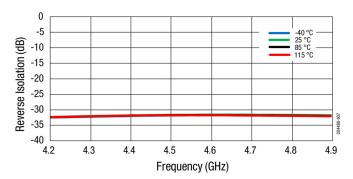


Figure 5. Input Return Loss (dB) vs Frequency

Figure 6. Output Return Loss (dB) vs Frequency



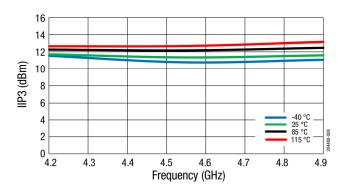


Figure 7. Reverse Isolation (dB) vs Frequency (GHz)

Figure 8. IIP3 (dBm) vs Frequency (GHz)

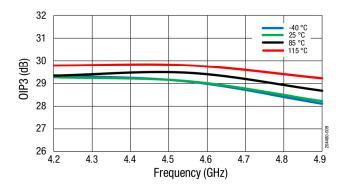


Figure 9. OIP3 (dBm) vs Frequency (GHz)

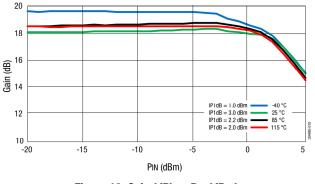


Figure 10. Gain (dB) vs PIN (dBm)

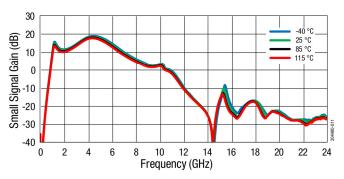


Figure 11. Small Signal Gain (dB) vs Frequency (GHz)

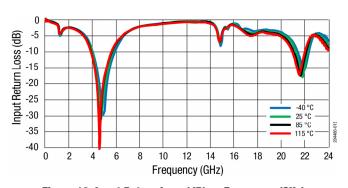


Figure 12. Input Return Loss (dB) vs Frequency (GHz)

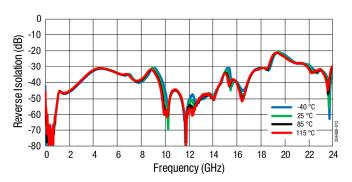


Figure 13. Reverse Isolation (dB) vs Frequency (GHz)

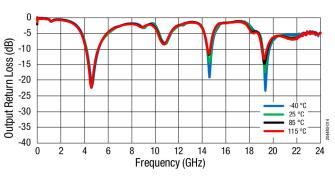


Figure 14. Output Return Loss (dB) vs Frequency (GHz)

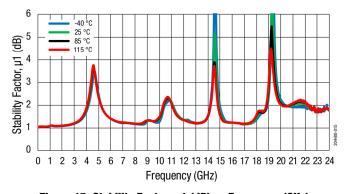


Figure 15. Stability Factor,  $\mu 1$  (dB) vs Frequency (GHz)

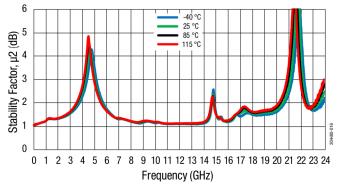


Figure 16. Stability Factor, μ2 (dB) vs Frequency (GHz)

Table 6. SKY67183-396LF Electrical Specifications: 3300 to 3800 MHz Optimized BOM in Table  $9^1$  (VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

| Parameter   | Symbol     | Test Condition   | Min                          | Тур                          | Max                          | Units                    |
|---|------------|--|------------------------------|------------------------------|------------------------------|--------------------------|
| RF Specifications   |            |  |                              |                              |                              |                          |
| Noise figure  | NF         | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |                              | 0.42<br>0.42<br>0.43<br>0.49 | 0.72<br>0.72<br>0.72<br>0.80 | dB<br>dB<br>dB<br>dB     |
| Gain  | S21        | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   | 16.9<br>17.0<br>17.0<br>16.9 | 19.1<br>19.1<br>19.1<br>18.9 |                              | dB<br>dB<br>dB           |
| Input return loss   | S11        | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   | 9.6<br>11.2<br>15.4<br>18.3  | 12.3<br>14.4<br>20.6<br>31.9 |                              | dB<br>dB<br>dB<br>dB     |
| Output return loss  | S22        | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   | 6.5<br>7.7<br>10.1<br>13.1   | 9.8<br>11.8<br>16.4<br>19.0  |                              | dB<br>dB<br>dB<br>dB     |
| Reverse isolation   | S12        | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   | 29.6<br>29.4<br>29.0<br>28.8 | 33.1<br>32.8<br>32.4<br>32.1 |                              | dB<br>dB<br>dB<br>dB     |
| Third order output intercept point                                  | OIP3       | PIN = -20 dBm, △ Tone = 1 MHz:<br>@ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz | 27.0<br>27.1<br>25.8<br>28.9 | 30.3<br>30.3<br>28.9<br>34.7 |                              | dBm<br>dBm<br>dBm<br>dBm |
| 1 dB output compression point                                       | OP1dB      | @ 3300 MHz<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   | 18.1<br>18.0<br>17.9<br>18.4 | 20.3<br>20.2<br>20.1<br>20.6 |                              | dBm<br>dBm<br>dBm<br>dBm |
| DC Specifications   |            |  |                              |                              |                              |                          |
| Supply voltage  | VDD        |  |                              | 5.0                          |                              | V                        |
| Quiescent current   | IDD        |  | 45                           | 56                           | 67                           | mA                       |
| Settling time 0.3 dB <sup>2</sup> Settling time 0.1 dB <sup>3</sup> | Ts1<br>Ts2 | @ 3600 MHz   |                              | 0.28<br>0.29                 |                              | us<br>us                 |

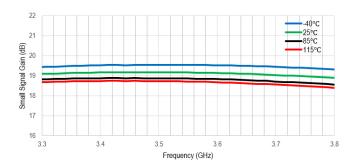
<sup>&</sup>lt;sup>1</sup> Verified by characterization.

<sup>&</sup>lt;sup>2</sup> Settling time 0.3 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady-state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady-state "on" level.

#### **Typical Performance Characteristics**

### 3300 to 3800 MHz, (VDD = 5 V, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ Unless Otherwise Noted)



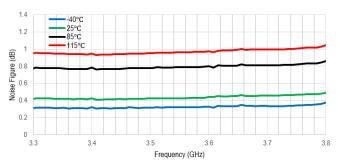


Figure 17. Small Signal Gain (dB) vs Frequency (GHz)

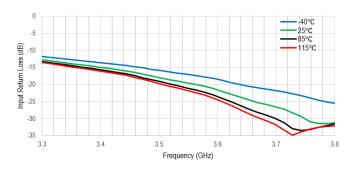


Figure 18. Noise Figure (dB) vs Frequency (GHz)

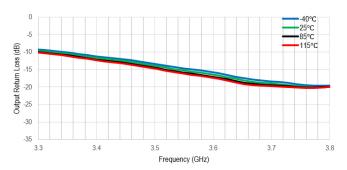


Figure 19. Input Return Loss (dB) vs Frequency

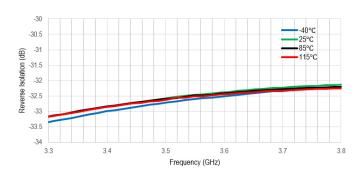


Figure 20. Output Return Loss (dB) vs Frequency

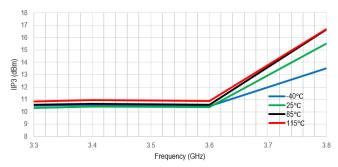


Figure 21. Reverse Isolation (dB) vs Frequency (GHz)

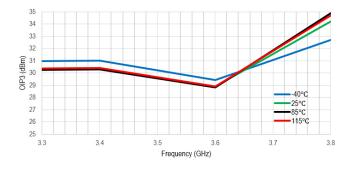


Figure 22. IIP3 (dBm) vs Frequency (GHz)

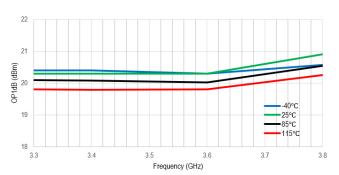


Figure 23. OIP3 (dBm) vs Frequency (GHz)

Figure 24. OP1dB (dBm) vs Frequency (GHz)

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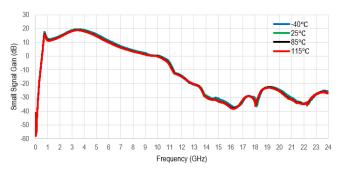


Figure 25. Small Signal Gain (dB) vs Frequency (GHz)

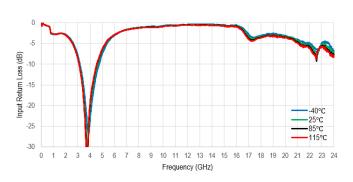


Figure 26. Input Return Loss (dB) vs Frequency (GHz)

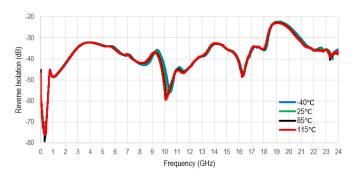


Figure 27. Reverse Isolation (dB) vs Frequency (GHz)

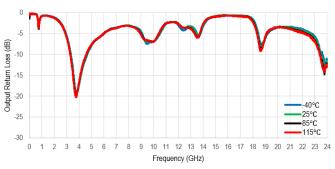


Figure 28. Output Return Loss (dB) vs Frequency (GHz)

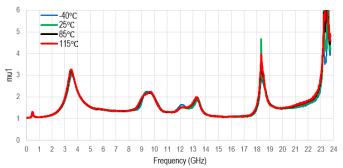


Figure 29. Stability Factor, µ1 (dB) vs Frequency (GHz)

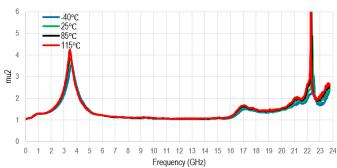


Figure 30. Stability Factor, µ2 (dB) vs Frequency (GHz)

Table 7. SKY67183-396LF Electrical Specifications: 2300 to 2700 MHz Optimized BoM in Table  $10^1$  (VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

| Parameter  | Symbol     | Test Condition   | Min            | Тур                     | Max                  | Units             |
|--|------------|--|----------------|-------------------------|----------------------|-------------------|
| RF Specifications  |            |  |                |                         |                      |                   |
| Noise figure   | NF         | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |                | 0.36<br>0.41<br>0.43    | 0.75<br>0.75<br>0.85 | dB<br>dB<br>dB    |
| Gain   | S21        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   | 20<br>20<br>19 | 21.7<br>21.4<br>20.9    |                      | dB<br>dB<br>dB    |
| Input return loss  | S11        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   | 9<br>10<br>10  | 13<br>16.4<br>18.7      |                      | dB<br>dB<br>dB    |
| Output return loss   | S22        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   | 7<br>9<br>9    | 11.2<br>13.5<br>12.6    |                      | dB<br>dB<br>dB    |
| Reverse isolation  | IS12I      | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |                | 33.8<br>33.4<br>33.2    |                      | dB<br>dB<br>dB    |
| Third order output intercept point                                     | OIP3       | PIN = -20 dBm, Δ Tone = 1 MHz:<br>@ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz | 29<br>29<br>29 | +32.2<br>+32.7<br>+33.4 |                      | dBm<br>dBm<br>dBm |
| 1 dB output compression point  | OP1dB      | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   | 18<br>20<br>20 | +19.5<br>+22<br>+22.1   |                      | dBm<br>dBm<br>dBm |
| DC Specifications  |            |  |                |                         |                      |                   |
| Supply voltage   | VDD        |  |                | 5.0                     |                      | V                 |
| Quiescent current  | IDD        |  |                | 56                      |                      | mA                |
| Settling time 0.3 dB <sup>2</sup><br>Settling time 0.1 dB <sup>3</sup> | Ts1<br>Ts2 | @ 2500 MHz   |                | 0.3<br>0.33             |                      | us<br>us          |

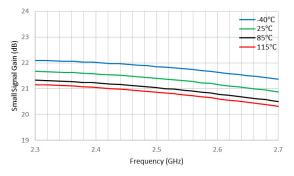
<sup>&</sup>lt;sup>1</sup> Verified by characterization.

<sup>&</sup>lt;sup>2</sup> Settling time 0.3 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady-state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady-state "on" level.

#### **Typical Performance Characteristics**

# 2300 to 2700 MHz, (VDD = 5 V, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance (Zo) = 50 $\Omega$ , Unless Otherwise Noted)



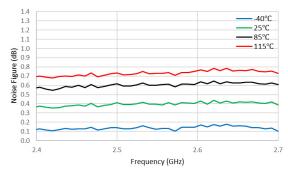
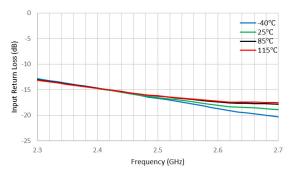


Figure 31. Small Signal Gain (dB) vs Frequency (GHz)

Figure 32. Noise Figure (dB) vs Frequency (GHz)



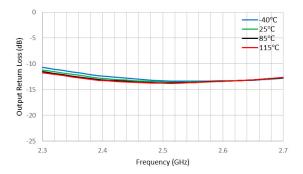
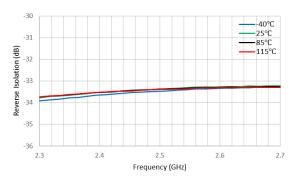


Figure 33. Input Return Loss (dB) vs Frequency

Figure 34. Output Return Loss (dB) vs Frequency



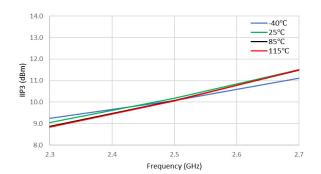


Figure 35. Reverse Isolation (dB) vs Frequency (GHz)

Figure 36. IIP3 (dBm) vs Frequency (GHz)

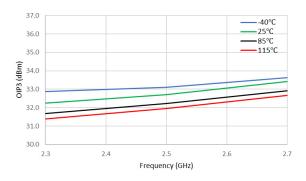


Figure 37. OIP3 (dBm) vs Frequency (GHz)

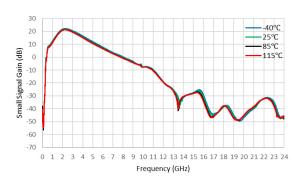


Figure 39. Small Signal Gain (dB) vs Frequency (GHz)

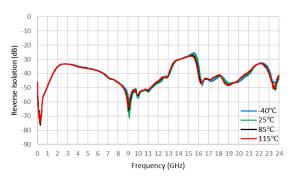


Figure 41. Reverse Isolation (dB) vs Frequency (GHz)

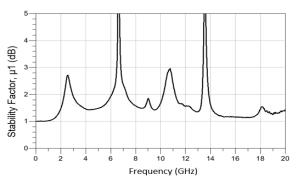


Figure 43. Stability Factor, µ1 (dB) vs Frequency (GHz) at -40 °C

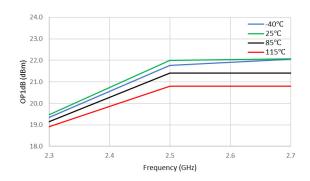


Figure 38. OP1dB (dBm) vs Frequency (GHz)

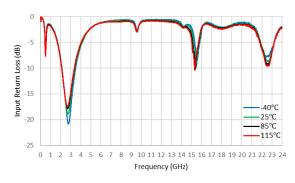


Figure 40. Input Return Loss (dB) vs Frequency (GHz)

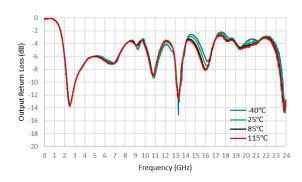


Figure 42. Output Return Loss (dB) vs Frequency (GHz)

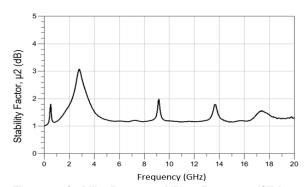


Figure 44. Stability Factor, μ2 (dB) vs Frequency (GHz) at -40 °C

Table 8. SKY67183-396LF Electrical Specifications: 1700 to 2200 MHz Optimized BOM in Table 10 $^{1}$  (VDD = 5.0 V, Enable = GND, TA = +25 $^{\circ}$ C, PIN = -20 dBm, Characteristic Impedance [Z0] = 50  $\Omega$ , Unless Otherwise Noted)

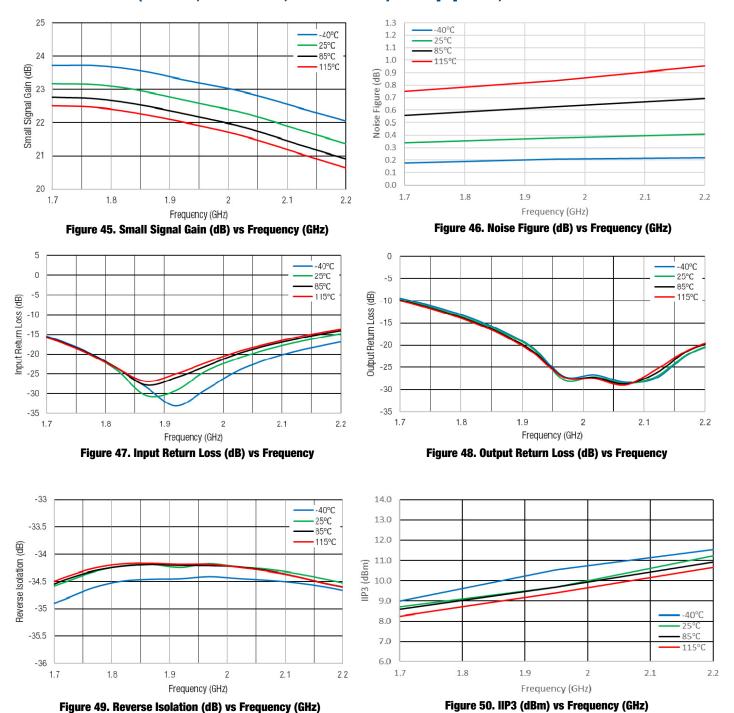
| Parameter                          | Symbol | Test Condition                        | Min  | Тур   | Max  | Units |
|------------------------------------|--------|---------------------------------------|------|-------|------|-------|
| RF Specifications                  | •      |                                       |      |       |      |       |
|                                    |        | @ 1700 MHz                            |      | 0.34  | 0.75 | dB    |
| Noise figure                       | NF     | @ 1950 MHz                            |      | 0.38  | 0.75 | dB    |
|                                    |        | @ 2200 MHz                            |      | 0.41  | 0.85 | dB    |
|                                    |        | @ 1700 MHz                            | 21.5 | 23.2  |      | dB    |
| Gain                               | IS21I  | @ 1950 MHz                            | 21   | 22.7  |      | dB    |
|                                    |        | @ 2200 MHz                            | 19.5 | 21.5  |      | dB    |
|                                    |        | @ 1700 MHz                            | 10   | 15.7  |      | dB    |
| Input return loss                  | IS11I  | @ 1950 MHz                            | 10   | 26.2  |      | dB    |
|                                    |        | @ 2200 MHz                            | 10   | 14.8  |      | dB    |
|                                    |        | @ 1700 MHz                            | 7    | 9.7   |      | dB    |
| Output return loss                 | IS22I  | @ 1950 MHz                            | 10   | 25.2  |      | dB    |
|                                    |        | @ 2200 MHz                            | 10   | 20.6  |      | dB    |
|                                    |        | @ 1700 MHz                            |      | 34.4  |      | dB    |
| Reverse isolation                  | IS12I  | @ 1950 MHz                            |      | 34.2  |      | dB    |
|                                    |        | @ 2200 MHz                            |      | 34.6  |      | dB    |
|                                    |        | PIN = -20 dBm, $\Delta$ Tone = 1 MHz: |      |       |      |       |
| Third order output intercept point | OIP3   | @ 1700 MHz                            | 28   | +31.8 |      | dBm   |
| mild order output intercept point  | 011 3  | @ 1950 MHz                            | 28   | +32.2 |      | dBm   |
|                                    |        | @ 2200 MHz                            | 28   | +32.5 |      | dBm   |
|                                    |        | @ 1700 MHz                            | 17.5 | +19.1 |      | dBm   |
| 1 dB output compression point      | OP1dB  | @ 1950 MHz                            | 18.0 | +20.2 |      | dBm   |
|                                    |        | @ 2200 MHz                            | 19.0 | +21.1 |      | dBm   |
| DC Specifications                  |        |                                       |      |       |      |       |
| Supply voltage                     | VDD    |                                       |      | 5     |      | V     |
| Quiescent current                  | ldd    |                                       |      | 56    |      | mA    |
| Settling time 0.3 dB <sup>2</sup>  | Ts1    | 0.4070.484                            |      | 0.3   |      | us    |
| Settling time 0.1 dB <sup>3</sup>  | Ts2    | @ 1950 MHz                            |      | 0.33  |      | us    |

<sup>&</sup>lt;sup>1</sup> Verified by characterization.

<sup>2</sup> Settling time 0.3 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady-state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the LNA enable reaches 50% of LNA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady-state "on" level.

# Typical Performance Characteristics 1700 to 2200 MHz (VDD = 5 V, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , Unless Otherwise Noted



#### DATA SHEET • SKY67183-396LF: 400 TO 6000 MHz BROADBAND LNA

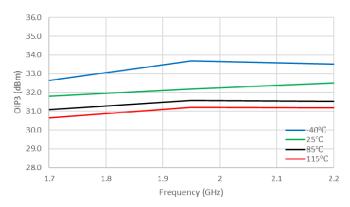


Figure 51. OIP3 (dBm) vs Frequency (GHz)

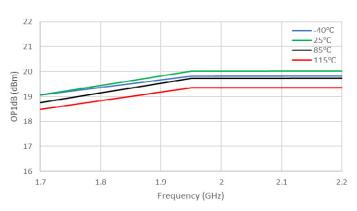


Figure 52. OP1dB (dBm) vs Frequency (GHz)

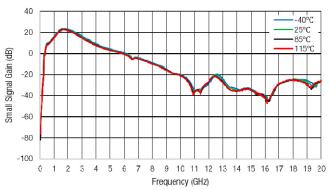


Figure 53. Small Signal Gain (dB) vs Frequency (GHz)

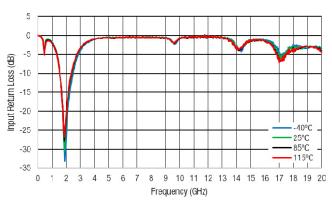


Figure 54. Input Return Loss (dB) vs Frequency (GHz)

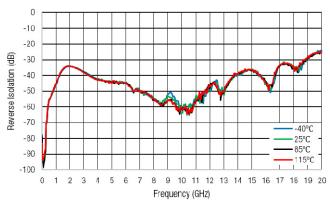


Figure 55. Reverse Isolation (dB) vs Frequency (GHz)

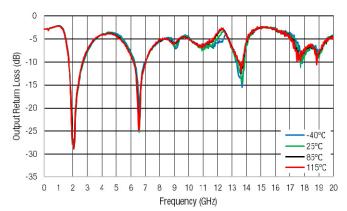


Figure 56. Output Return Loss (dB) vs Frequency (GHz)

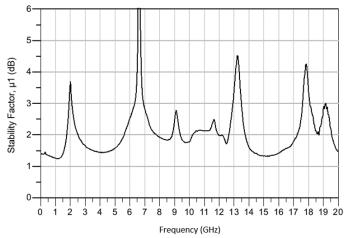
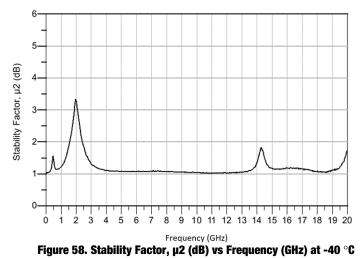


Figure 57. Stability Factor,  $\mu 1$  (dB) vs Frequency (GHz) at -40 °C



# **Evaluation Board Description**

The SKY67183-396LF Evaluation Board is used to test the performance of the SKY67183-396LF LNA. An Evaluation Board schematic diagram is shown below. Bill of Materials (BOMs) for

Evaluation Boards optimized for 4200 to 4900 MHz, 3300 to 3800, 2300 to 2700 MHz, and 1700 to 2200 MHz appear in the following pages. An EVB assembly diagram and layer details are also included in this data sheet.

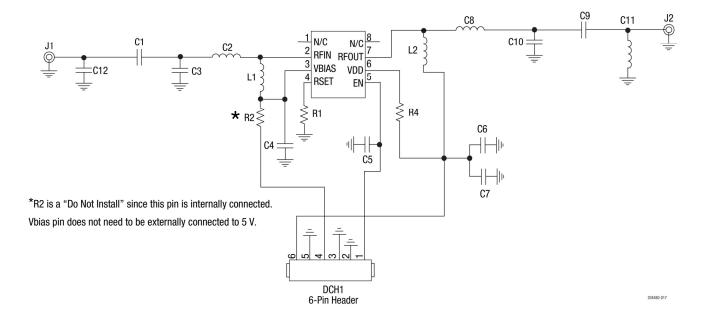


Figure 59. SKY67183-396LF Evaluation Board Schematic

Table 9. SKY67183-396 Evaluation Board Bill of Materials (BOM) for 4200 to 4900 MHz Tuning

| Component | Value  | Size  | Part Number        |
|-----------|--------|-------|--------------------|
| C1        | 1.8 pF | 0402  | GJM1555C1H1R8BB01D |
| C2        | 0.8 nH | 03015 | LQW04AN0N8C00D     |
| C3        | 0.4 pF | 0402  | GJM1555C1HR40WB01D |
| C4        | DNI    |       |                    |
| C5        | DNI    |       |                    |
| C6        | DNI    |       |                    |
| C7        | 4.7 uF | 0402  | GRM155C80J475MEAAD |
| C8        | 2.2 pF | 0402  | GRM1555C1H2R2BA01D |
| C9        | 0 Ω    | 0402  | Not critical       |
| C10       | 1.0 nH | 0402  | LQG15HS1N0S02D     |
| C11       | DNI    |       |                    |
| C12       | DNI    |       |                    |
| L1        | 18 nH  | 0402  | LQW15AN18NG8ZD     |
| L2        | 6.2 nH | 0402  | LQG15HS6N2S02D     |
| R1        | 8.2 kΩ | 0201  | Not critical       |
| R2        | DNI    |       |                    |
| R4        | 100 Ω  | 0201  | Not critical       |

Table 10. SKY67183-396LF Evaluation Board Bill of Materials (BOM) for 3300 to 3800 MHz Tuning

| Component | Value  | Size | Part Number        |
|-----------|--------|------|--------------------|
| C1        | 1.8 pF | 0402 | GJM1555C1H1R8BB01  |
| C2        | 1.8 nH | 0402 | LQW15AN1N8C00      |
| C3        | 0.4 pF | 0402 | GJM1555C1HR40WB01D |
| C4        | DNI    |      |                    |
| C5        | DNI    |      |                    |
| C6        | DNI    |      |                    |
| C7        | 4.7 uF | 0402 | GRM155C80J475MEAAD |
| C8        | 5.6 pF | 0402 | GRM1555C1H5R6BA01D |
| C9        | 0 Ω    | 0402 | Not critical       |
| C10       | 1.8 nH | 0402 | LQG15HS1N8S02D     |
| C11       | DNI    |      |                    |
| C12       | DNI    |      |                    |
| L1        | 12 nH  | 0402 | LQW15AN12NG8ZD     |
| L2        | 5.6 nH | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 kΩ | 0201 | Not critical       |
| R2        | DNI    |      |                    |
| R4        | 100 Ω  | 0201 | Not critical       |

Table 11. SKY67183-396LF Evaluation Board Bill of Materials (BOM) for 2300 to 2700 MHz Tuning

| Component | Value  | Size | Part Number        |
|-----------|--------|------|--------------------|
| C1        | 5.0 pF | 0402 | GJM1555C1H5R0BB01D |
| C2        | 2.7 nH | 0402 | LQW15AN2N7B8ZD     |
| C3        | 0.4 pF | 0402 | GJM1555C1HR40WB01D |
| C4        | 10 pF  | 0402 | GRM1555C1H100JA01D |
| C5        | DNI    |      |                    |
| C6        | DNI    |      |                    |
| C7        | 4.7 uF | 0402 | GRM155C80J475MEAAD |
| C8        | 22 pF  | 0402 | GRM1555C1H220JA01  |
| C9        | 1.8 pF | 0402 | GRM1555C1H1R8BA01D |
| C10       | 3.3 nH | 0402 | LQG15HS3N3S02D     |
| C11       | DNI    |      |                    |
| C12       | DNI    |      |                    |
| L1        | 22 nH  | 0402 | LQW15AN22NG8ZD     |
| L2        | 5.6 nH | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 kΩ | 0201 | Not critical       |
| R2        | DNI    |      |                    |
| R4        | 100 Ω  | 0201 | Not critical       |

Table 12. SKY67183-396LF Evaluation Board Bill of Materials (BOM) for 1700 to 2200 MHz Tuning

| Component | Value    | Size | Part Number        |
|-----------|----------|------|--------------------|
| C1        | 5.0 pF   | 0402 | GJM1555C1H5R0BB01D |
| C2        | 4.7 nH   | 0402 | LQW15AN4N7B8ZD     |
| C3        | 0.4 pF   | 0402 | GJM1555C1HR40WB01D |
| C4        | 15 pF    | 0402 | GRM1555C1H150JA01D |
| C5        | DNI      |      |                    |
| C6        | DNI      |      |                    |
| C7        | 4.7 uF   | 0402 | GRM155C80J475MEAAD |
| C8        | 22 pF    | 0402 | GRM1555C1H220JA01  |
| C9        | 1.8 pF   | 0402 | GRM1555C1H1R8BA01D |
| C10       | 6.2 nH   | 0402 | LQG15HS6N2S02D     |
| C11       | 300 Ohm  | 0402 | ERJ-2RKF3000C      |
| C12       | DNI      |      |                    |
| L1        | 22 nH    | 0402 | LQW15AN22NG8ZD     |
| L2        | 5.6 nH   | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 K0hm | 0201 | ERJ-1GNF8201C      |
| R2        | DNI      |      |                    |
| R4        | 100 Ohm  | 0201 | ERJ-1GNF1000C      |

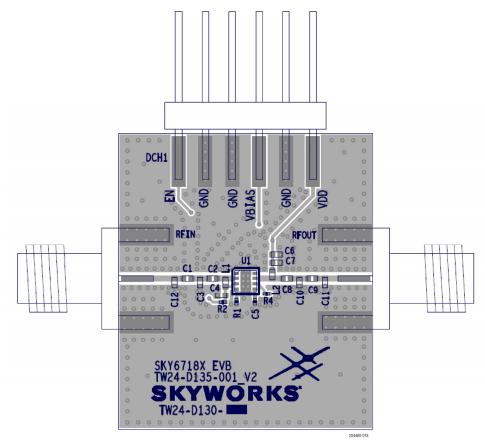


Figure 60. SKY67183-396LF EVB Assembly Diagram

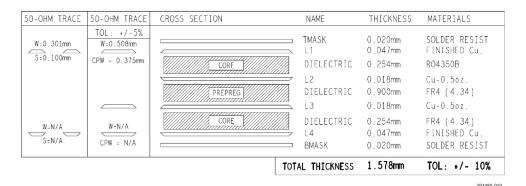


Figure 61. SKY67183-396LF EVB Layer Details

## **Package Dimensions**

Typical part marking and PCB layout footprint for the SKY67183-396LF appear below, followed by package and tape and reel dimensions.

### **Package and Handling Information**

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY67183-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

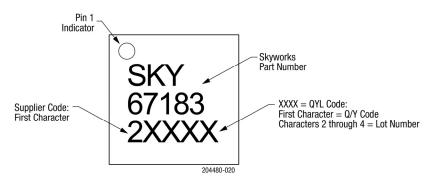


Figure 62. SKY67183-396LF Typical Part Marking

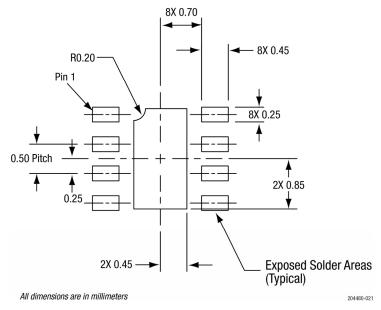
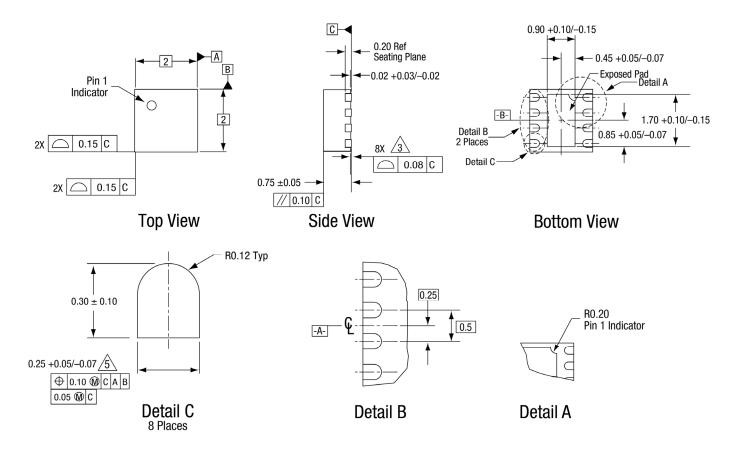


Figure 63. SKY67183-396LF PCB Layout Footprint

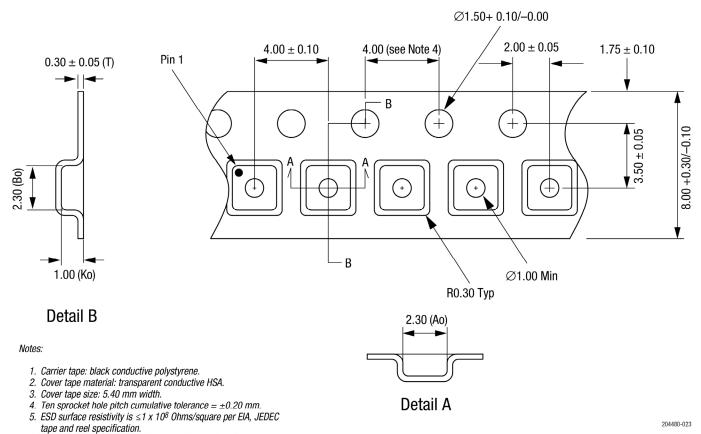


#### Notes:

- 1. All measurements are in millimeters.
- 2. Dimensions and tolerances according to ASME Y14.5M-1994.
- 3. Coplanarity applies to the exposed heat sink ground pad as well as the terminals.
- 4. Plating requirement per source control drawing (SCD) 2504.
- 5. Dimension applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.

Figure 64. SKY67183-396LF Package Dimensions

204480-022



6. Ao and Bo measurement point to be 0.30 mm from bottom pocket.
7. All measurements are in millimeters.

Figure 65. SKY67183-396LF Tape and Reel Dimensions

# **Ordering Information**

| Part Number    | Product Description                           | Evaluation Board Part Number            |
|----------------|---|---|
| SKY67183-396LF | 400 to 6000 MHz Broadband Low-Noise Amplifier | SKY67183-396EK1 (4.2 to 4.9 GHz Tuning) |
|                |   | SKY67183-396EK2 (3.3 to 3.8 GHz Tuning) |
|                |   | SKY67183-396EK3 (2.3 to 2.7 GHz Tuning) |
|                |   | SKY67183-396EK4 (1.7 to 2.2 GHz Tuning) |

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